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## FGA50T65SHD 650 V, 50 A Field Stop Trench IGBT

#### Features

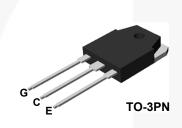
- Maximum Junction Temperature : T<sub>J</sub> =175<sup>o</sup>C
- · Positive Temperature Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage:  $V_{CE(sat)}$  =1.6 V(Typ.) @ I<sub>C</sub> = 50 A
- + 100% of the Parts Tested for  $I_{\text{LM}}(1)$
- High Input Impedance
- Fast Switching
- Tighten Parameter Distribution
- · RoHS Compliant

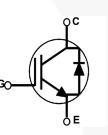
#### **General Description**

Using novel field stop IGBT technology, Fairchild's new series of field stop 3<sup>rd</sup> generation IGBTs offer the optimum performance for solar inverter, UPS, welder, telecom, ESS and PFC applications where low conduction and switching losses are essential.

#### Applications

• Solar Inverter, UPS, Welder, Telecom, ESS, PFC





#### Absolute Maximum Ratings T<sub>c</sub> = 25°C unless otherwise noted

Symbol	Description		FGA50T65SHD	Unit
V <sub>CES</sub>	Collector to Emitter Voltage		650	V
V <sub>GES</sub>	Gate to Emitter Voltage		± 20	V
	Transient Gate to Emitter Voltage		± 30	V
I <sub>C</sub>	Collector Current	@ T <sub>C</sub> = 25°C	100	A
·C	Collector Current	@ T <sub>C</sub> = 100°C	50	A
I <sub>LM (1)</sub>	Pulsed Collector Current $@ T_C = 25^{\circ}C$		150	A
I <sub>CM (2)</sub>	Pulsed Collector Current		150	А
I <sub>F</sub>	Diode Forward Current	@ T <sub>C</sub> = 25°C	60	А
۰F	Diode Forward Current	@ T <sub>C</sub> = 100°C	30	А
I <sub>FM (2)</sub>	Pulsed Diode Maximum Forward Curren	t	150	А
P <sub>D</sub>	Maximum Power Dissipation	@ T <sub>C</sub> = 25°C	319	W
. D	Maximum Power Dissipation	@ T <sub>C</sub> = 100°C	160	W
TJ	Operating Junction Temperature		-55 to +175	°C
T <sub>stg</sub>	Storage Temperature Range		-55 to +175	°C
Τ <sub>L</sub>	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C

Notes:

1.  $V_{CC}$  = 400 V,  $V_{GE}$  = 15 V, I\_C =150 A, R\_G = 30  $\Omega,$  Inductive Load

2. Repetitive rating: Pulse width limited by max. junction temperature

April 2015

#### Thermal Characteristics

Symbol	Parameter	FGA50T65SHD	Unit	
R <sub>0JC</sub> (IGBT)	Thermal Resistance, Junction to Case, Max.	0.47	°C/W	
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case, Max.	1.25	°C/W	
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	40	°C/W	

#### Package Marking and Ordering Information

Pare Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FGA50T65SHD	FGA50T65SHD	TO-3PN	Tube	-	-	30

#### Electrical Characteristics of the IGBT T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	teristics					
BV <sub>CES</sub>	Collector to Emitter Breakdown Voltage	V <sub>GE</sub> = 0V, I <sub>C</sub> = 1 mA	650	-	-	V
$\Delta BV_{CES}/\Delta TJ$	Temperature Coefficient of Breakdown Voltage	$I_{\rm C} = 1$ mA, Reference to 25°C	-	0.6	-	V/ºC
I <sub>CES</sub>	Collector Cut-Off Current	V <sub>CE</sub> = V <sub>CES</sub> , V <sub>GE</sub> = 0 V	-	-	250	μA
I <sub>GES</sub>	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±400	nA
On Charac	teristics		1		1	
V <sub>GE(th)</sub>	G-E Threshold Voltage	I <sub>C</sub> = 50 mA, V <sub>CE</sub> = V <sub>GE</sub>	4.0	5.5	7.5	V
		I <sub>C</sub> = 50 A, V <sub>GE</sub> = 15 V	-	1.6	2.1	V
V <sub>CE(sat)</sub>	Collector to Emitter Saturation Voltage	$I_{C} = 50 \text{ A, } V_{GE} = 15 \text{ V,}$ $T_{C} = 175^{\circ}\text{C}$	-	2.14	-	V
Dynamic C	Characteristics					
C <sub>ies</sub>	Input Capacitance		-	2516	-	pF
C <sub>oes</sub>	Output Capacitance	V <sub>CE</sub> = 30 V <sub>,</sub> V <sub>GE</sub> = 0 V, f = 1MHz	-	100	-	pF
C <sub>res</sub>	Reverse Transfer Capacitance		-	31	-	pF
Switching	Characteristics				•	
t <sub>d(on)</sub>	Turn-On Delay Time		-	22.4	-	ns
t <sub>r</sub>	Rise Time		-	38.4	-	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	V <sub>CC</sub> = 400 V, I <sub>C</sub> = 50 A,	-	73.6	-	ns
t <sub>f</sub>	Fall Time	R <sub>G</sub> = 6 Ω, V <sub>GE</sub> = 15 V,	-	12.8	-	ns
Eon	Turn-On Switching Loss	Inductive Load, $T_C = 25^{\circ}C$	-	1280		uJ
E <sub>off</sub>	Turn-Off Switching Loss		-	384	-	uJ
E <sub>ts</sub>	Total Switching Loss		-	1664	-	uJ
t <sub>d(on)</sub>	Turn-On Delay Time		-	20.8	-	ns
t <sub>r</sub>	Rise Time		-	36.8	-	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	V <sub>CC</sub> = 400 V, I <sub>C</sub> = 50 A,	-	79.2	-	ns
	Fall Time	R <sub>G</sub> = 6 Ω, V <sub>GE</sub> = 15 V,	-	11.2	-	ns
Lf .		Inductive Load, T <sub>C</sub> = 175 <sup>o</sup> C	-	1920	_	uJ
	Turn-On Switching Loss		-	1920	-	uJ
t <sub>f</sub> E <sub>on</sub> E <sub>off</sub>	Turn-On Switching Loss Turn-Off Switching Loss	-	-	556	-	uJ

### Electrical Characteristics of the IGBT (Continued)

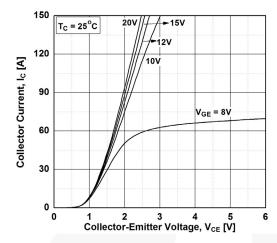
Symbol	Parameter	Test Conditions	Min.	Тур.	Max	Unit
Qg	Total Gate Charge	V <sub>CE</sub> = 400 V, I <sub>C</sub> = 50 A, V <sub>GE</sub> = 15 V	-	87	-	nC
Q <sub>ge</sub>	Gate to Emitter Charge		-	15.7	-	nC
Q <sub>gc</sub>	Gate to Collector Charge		-	33.6	-	nC

#### Electrical Characteristics of the Diode T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter		Test Conditions			Min.	Тур.	Мах	Unit
V <sub>FM</sub>	Diode Forward Voltage	I_ =	30 A	TC	<sub>c</sub> = 25°C	-	2.3	2.7	v
*FM		'F	50 A	T <sub>C</sub>	<sub>c</sub> = 175 <sup>o</sup> C	-	1.9	-	, v
E <sub>rec</sub>	Reverse Recovery Energy			T <sub>C</sub>	<sub>c</sub> = 175 <sup>o</sup> C	-	50	-	uJ
t <sub>rr</sub>	Diode Reverse Recovery Time	I <sub>F</sub> =30 A, dI <sub>F</sub> /dt = 200 A/μs	T <sub>C</sub>	<sub>c</sub> = 25°C		34.6	-	ns	
			T <sub>C</sub>	<sub>c</sub> = 175 <sup>o</sup> C	-	197	- T		
Q <sub>rr</sub>	Diode Reverse Recovery Charge	1			<sub>c</sub> = 25 <sup>o</sup> C	-	58.6	-	nC
αn				TC	<sub>c</sub> = 175 <sup>o</sup> C	-	810	-	

### **Typical Performance Characteristics**

#### Figure 1. Typical Output Characteristics





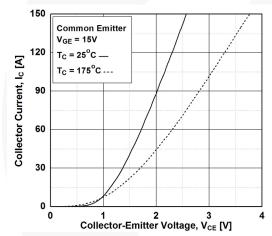


Figure 5. Saturation Voltage vs. V<sub>GE</sub>

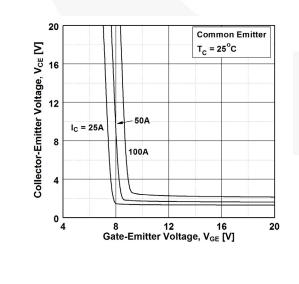
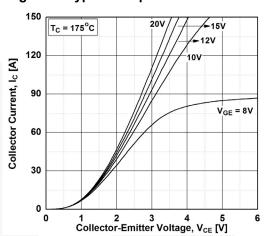


Figure 2. Typical Output Characteristics





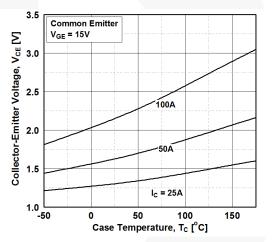
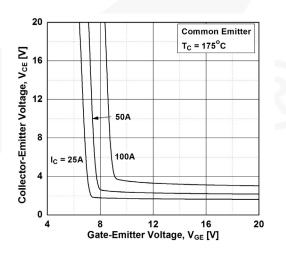
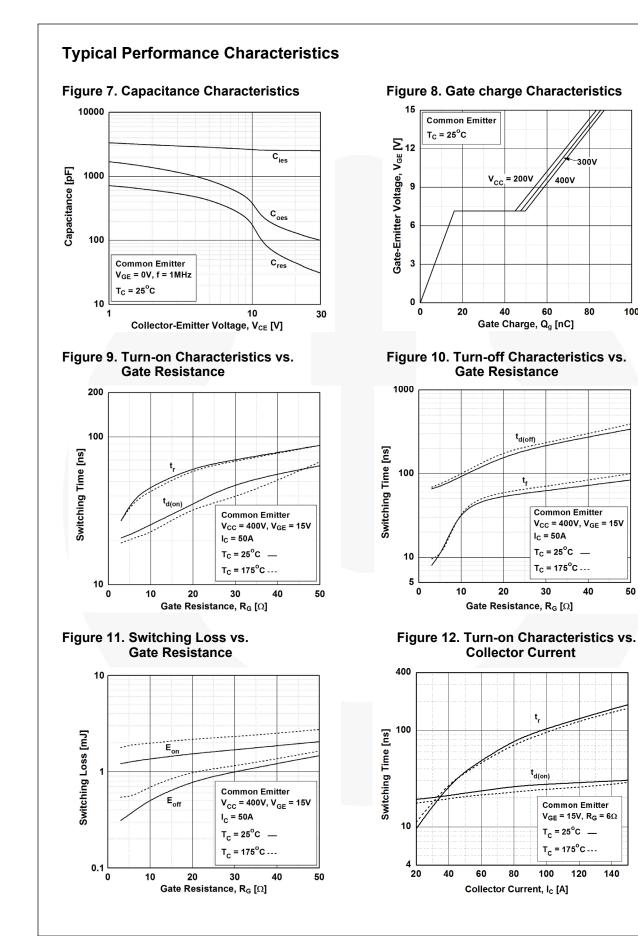


Figure 6. Saturation Voltage vs. V<sub>GE</sub>

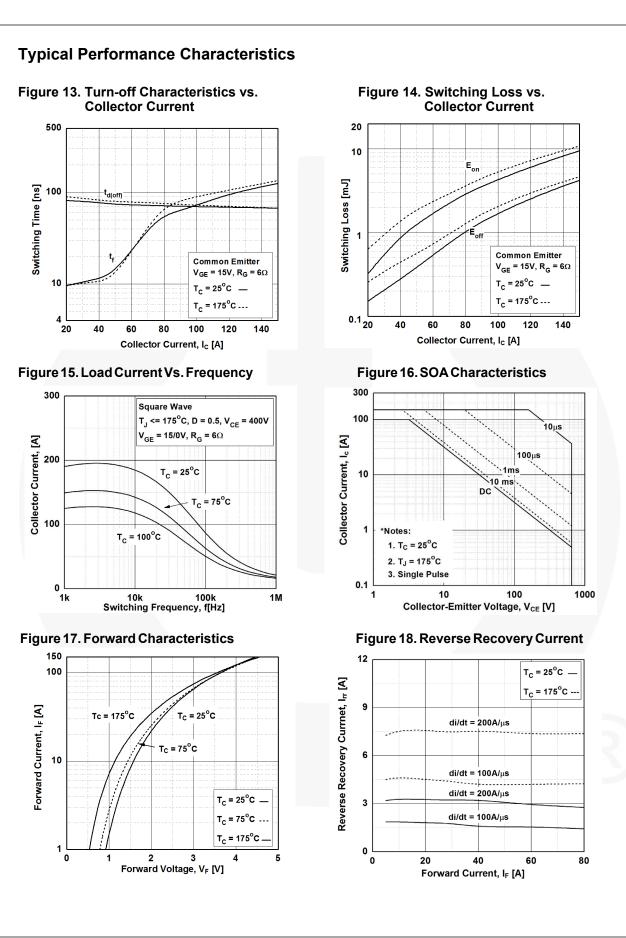


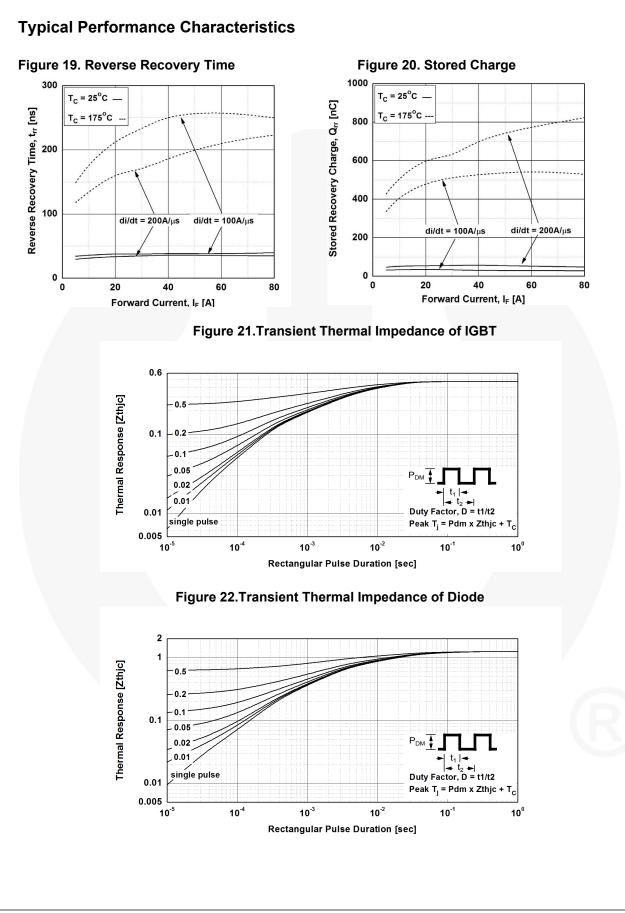
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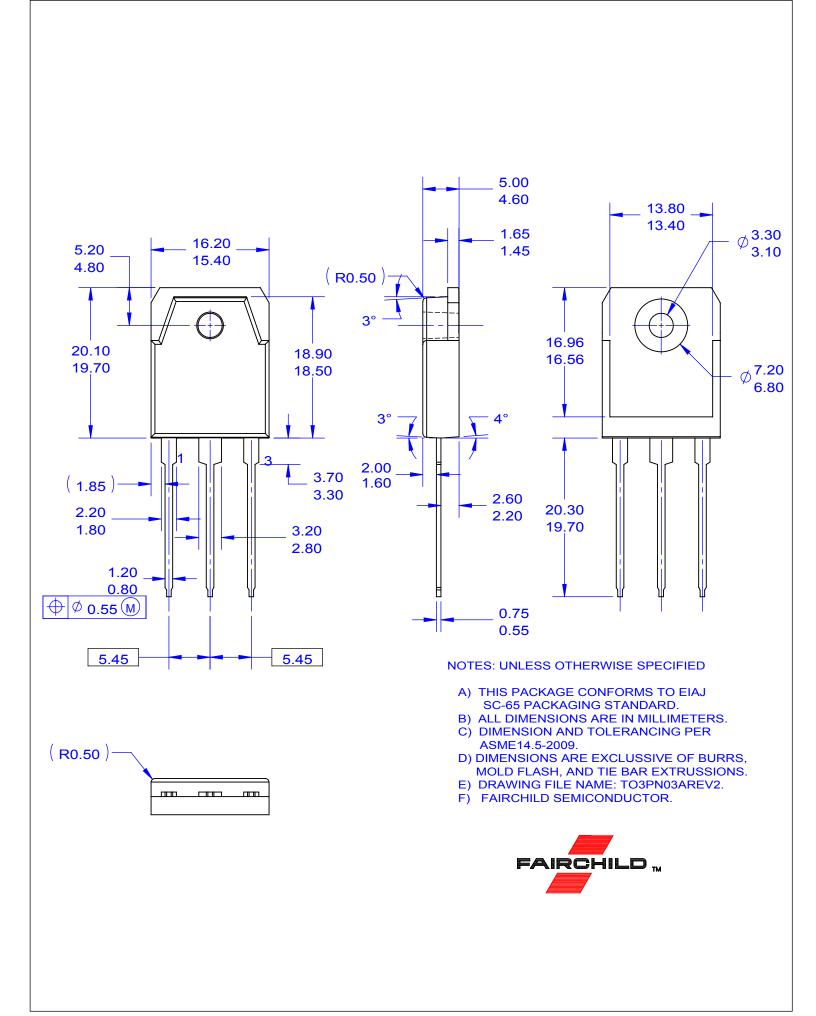
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